



3.3V CMOS SINGLE POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOP, 5 VOLT TOLERANT I/O

IDT74LVC1G79A

FEATURES:

- 0.5 MICRON CMOS Technology
- ESD > 2000V per MIL-STD-883, Method 3015;
> 200V using machine model (C = 200pF, R = 0)
- 0.65mm pitch PSOP package
- Extended commercial range of – 40°C to +85°C
- $V_{CC} = 3.3V \pm 0.3V$, Normal Range
- $V_{CC} = 1.65V$ to 3.6V, Extended Range
- $V_{CC} = 2.5V \pm 0.2V$
- CMOS power levels (0.4μW typ. static)
- Rail-to-Rail output swing for increased noise margin
- All inputs, outputs and I/O are 5 Volt tolerant
- Supports hot insertion

Drive Features for LVC1G79A:

- High Output Drivers: $\pm 24mA$
- Reduced system switching noise

APPLICATIONS:

- 5V and 3.3V mixed voltage systems
- Data communication and telecommunication systems

DESCRIPTION

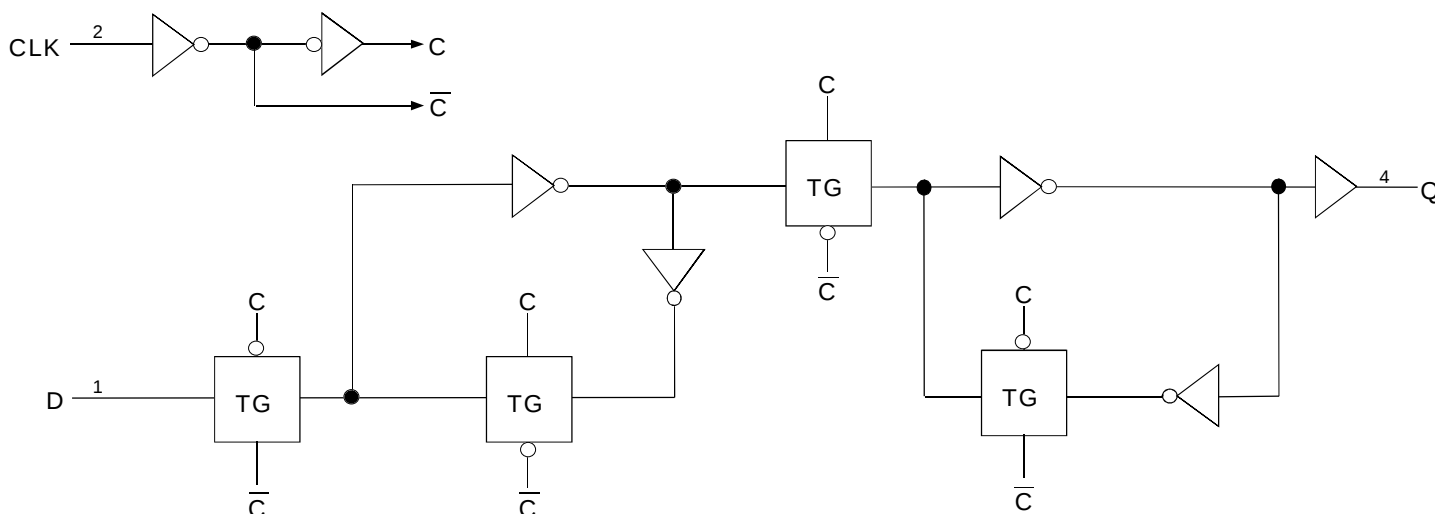
This single positive-edge-triggered D-type flip-flop is built using advanced dual metal CMOS technology. The LVC1G79A is designed for 2.3V to 3.6V V_{CC} operation.

When data at the data (D) input meets the setup time requirement, the data is transferred to the Q output on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input may be changed without affecting the levels at the outputs.

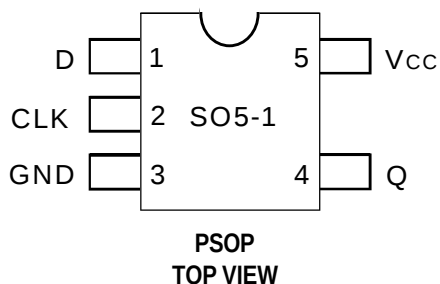
The LVC1G79A has been designed with a $\pm 24mA$ output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance.

Inputs can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V supply system.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Symbol	Description	Max.	Unit
V _{TERM}	Terminal Voltage with Respect to GND	−0.5 to +6.5	V
T _{STG}	Storage Temperature	− 65 to +150	°C
I _{OUT}	DC Output Current	− 50 to +50	mA
I _{IK} I _{OK}	Continuous Clamp Current, V _I < 0 or V _O < 0	− 50	mA
I _{CC} I _{SS}	Continuous Current through each V _{CC} or GND	±100	mA

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NOTE:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

PIN DESCRIPTION

Pin Names	Description
CLK	Data Inputs
D	Data Inputs
Q	Data Output

FUNCTION TABLE ⁽¹⁾

Inputs		Output
CLK	D	Q
↑	H	H
↑	L	L
L	X	Q ₀

NOTE:

- H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
↑ = LOW to HIGH transition

Q₀ = Level of Q before the indicated steady-state input conditions were established.

CAPACITANCE (T_A = +25°C, f = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
C _{IN}	Input Capacitance	V _{IN} = 0V	4.5	6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V	5.5	8	pF
C _{I/O}	I/O Port Capacitance	V _{IN} = 0V	6.5	8	pF

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NOTE:

- As applicable to the device type.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: TA = - 40°C To +85°C

Symbol	Parameter	Test Conditions		Min.	Typ. ⁽¹⁾	Max.	Unit
V _{IH}	Input HIGH Voltage Level	V _{CC} = 1.65V to 1.95V		0.65 x V _{CC}	—	—	V
		V _{CC} = 2.3V to 2.7V		1.7	—	—	V
		V _{CC} = 2.7V to 3.6V		2	—	—	V
V _{IL}	Input LOW Voltage Level	V _{CC} = 1.65V to 1.95V		—	—	0.35 x V _{CC}	V
		V _{CC} = 2.3V to 2.7V		—	—	0.7	
		V _{CC} = 2.7V to 3.6V		—	—	0.8	
I _{IH} I _{IL}	Input Leakage Current	V _{CC} = 3.6V	V _I = 0 to 5.5V	—	—	±5	μA
I _{OZH} I _{OZL}	High Impedance Output Current (3-State Output pins)	V _{CC} = 3.6V	V _I = 0 to 5.5V	—	—	±10	μA
V _{IK}	Clamp Diode Voltage	V _{CC} = 2.3V, I _{IN} = - 18mA		—	- 0.7	- 1.2	V
V _H	Input Hysteresis	V _{CC} = 3.3V		—	100	—	mV
I _{CCL} I _{CCH} I _{CCZ}	Quiescent Power Supply Current	V _{CC} = 3.6V	V _{IN} = GND or V _{CC}	—	—	10	μA
			3.6 ≤ V _{IN} ≤ 5.5V ⁽²⁾	—	—	10	
ΔI _{CC}	Quiescent Power Supply Current Variation	One input at V _{CC} - 0.6V, other inputs at V _{CC} or GND		—	—	500	μA

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NOTE:

1. Typical values are at V_{CC} = 3.3V, +25°C ambient.
2. This applies to 3-state outputs in the disabled state only.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	V _{CC} = 1.65V to 3.6V	I _{OH} = - 0.1mA	V _{CC} - 0.2	—	V
		V _{CC} = 1.65V	I _{OH} = - 4mA	1.2	—	
		V _{CC} = 2.3V	I _{OH} = - 8mA	1.7	—	
		V _{CC} = 2.7V	I _{OH} = - 12mA	2.2	—	
		V _{CC} = 3.0V		2.4	—	
		V _{CC} = 3.0V	I _{OH} = - 24mA	2.2	—	
V _{OL}	Output LOW Voltage	V _{CC} = 1.65V to 3.6V	I _{OL} = 0.1mA	—	0.2	V
		V _{CC} = 1.65V	I _{OL} = 4mA	—	0.45	
		V _{CC} = 2.3V	I _{OL} = 8mA	—	0.7	
		V _{CC} = 2.7V	I _{OL} = 12mA	—	0.4	
		V _{CC} = 3.0V	I _{OL} = 24mA	—	0.55	

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NOTE:

1. V_{IH} and V_{IL} must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V_{CC} range. TA = - 40°C to +85°C.

OPERATING CHARACTERISTICS, $T_A = 25^\circ\text{C}$

Symbol	Parameter	Test Conditions	$V_{CC} = 1.8V \pm 0.15V$	$V_{CC} = 2.5V \pm 0.2V$	$V_{CC} = 3.3V \pm 0.3V$	Unit
			Typical	Typical	Typical	
C_{PD}	Power Dissipation Capacitance	$C_L = 0pF$, $f = 10MHz$	—	—	—	pF

SWITCHING CHARACTERISTICS ⁽¹⁾

Symbol	Parameter	$V_{CC} = 1.8V \pm 0.15V$		$V_{CC} = 2.5V \pm 0.2V$		$V_{CC} = 2.7V$		$V_{CC} = 3.3V \pm 0.3V$		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
f_{MAX}										MHz
t_{PLH} t_{PHL}	Propagation Delay CLK to Q	1	14	1	7	—	6	1	5.2	ns
t_W	Pulse Width, CLK HIGH or LOW	5	—	3.3	—	3.3	—	3.3	—	ns
t_{SU}	Setup Time, data before CLK $\uparrow$, HIGH	5	—	3	—	3	—	3	—	ns
t_{SU}	Setup Time, data before CLK $\uparrow$, LOW	5	—	3	—	3	—	3	—	ns
t_H	Hold Time, data after CLK $\uparrow$	2	—	1	—	1	—	0	—	ns

NOTE:

1. See test circuits and waveforms. $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$.

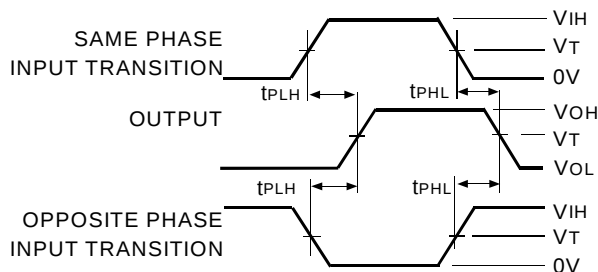
TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	V _{CC} (1)= 3.3V±0.3V	V _{CC} (1)= 2.7V	V _{CC} (2)= 2.5V±0.2V	Unit
V _{LOAD}	6	6	2 x V _{CC}	V
V _{IH}	2.7	2.7	V _{CC}	V
V _T	1.5	1.5	V _{CC} / 2	V
V _{LZ}	300	300	150	mV
V _{HZ}	300	300	150	mV
C _L	50	50	30	pF

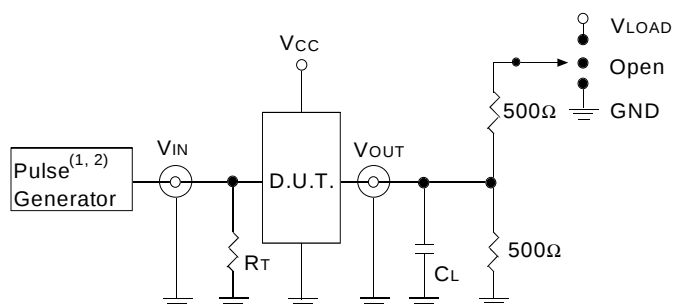
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PROPAGATION DELAY



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TEST CIRCUITS FOR ALL OUTPUTS



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DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

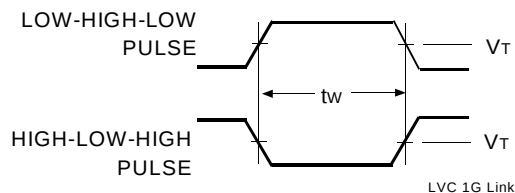
1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_r ≤ 2.5ns; t_r ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_r ≤ 2ns; t_r ≤ 2ns.

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	V _{LOAD}
Disable High Enable High	GND
All Other tests	Open

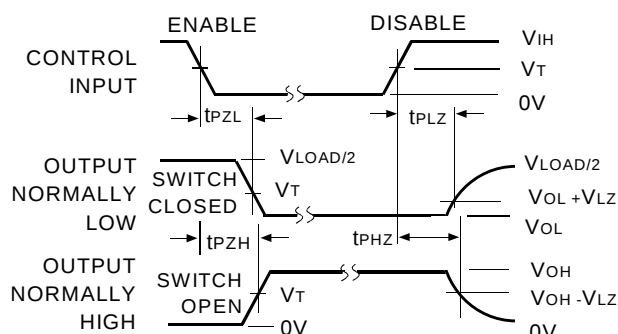
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PULSE WIDTH



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ENABLE AND DISABLE TIMES

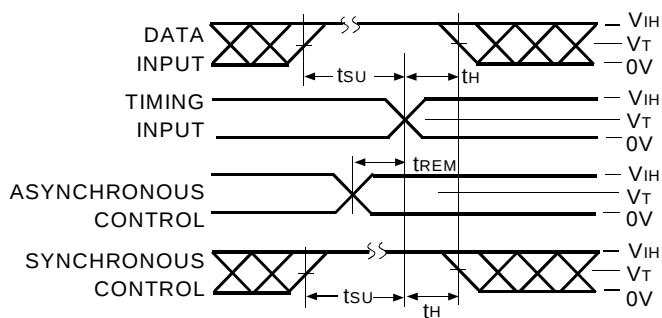


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NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

SET-UP, HOLD, AND RELEASE TIMES



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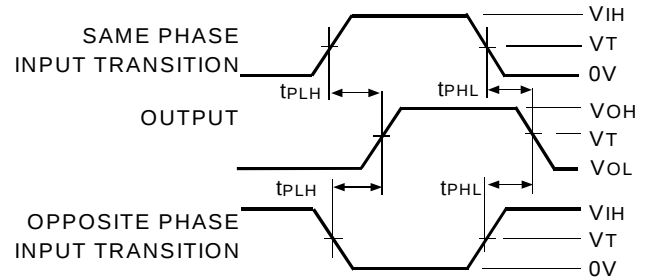
1.8V ± 0.15V TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	$V_{CC}^{(1)} = 1.8V \pm 0.15V$	Unit
V_{LOAD}	$2 \times V_{CC}$	V
V_{IH}	V_{CC}	V
V_T	$V_{CC}/2$	V
V_{LZ}	150	mV
V_{HZ}	150	mV
C_L	30	pF

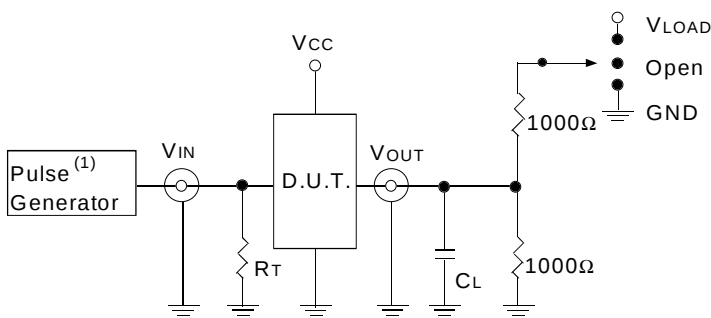
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PROPAGATION DELAY



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TEST CIRCUITS FOR ALL OUTPUTS



LVC 1G Link

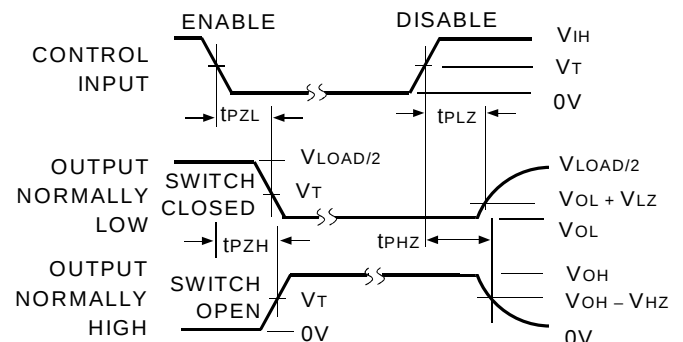
DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.
 R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTE:

1. Pulse Generator for All Pulses: Rate $\leq 10\text{MHz}$; $t_F \leq 2\text{ns}$; $t_R \leq 2\text{ns}$.

ENABLE AND DISABLE TIMES



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NOTE:

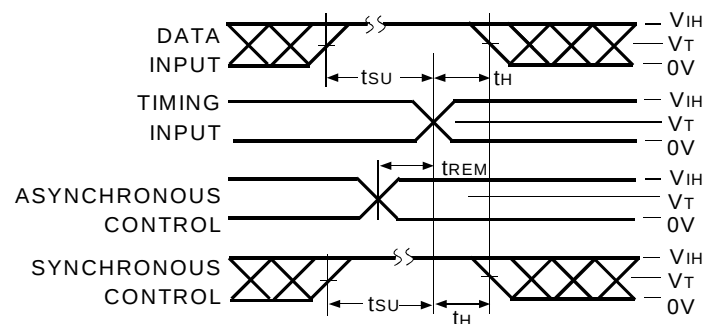
1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	V_{LOAD}
Disable High Enable High	GND
All Other tests	Open

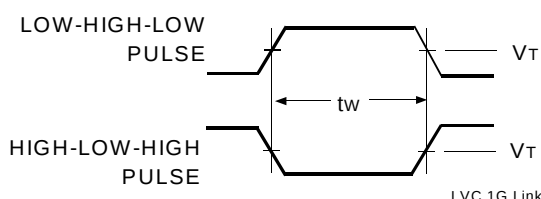
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SET-UP, HOLD, AND RELEASE TIMES



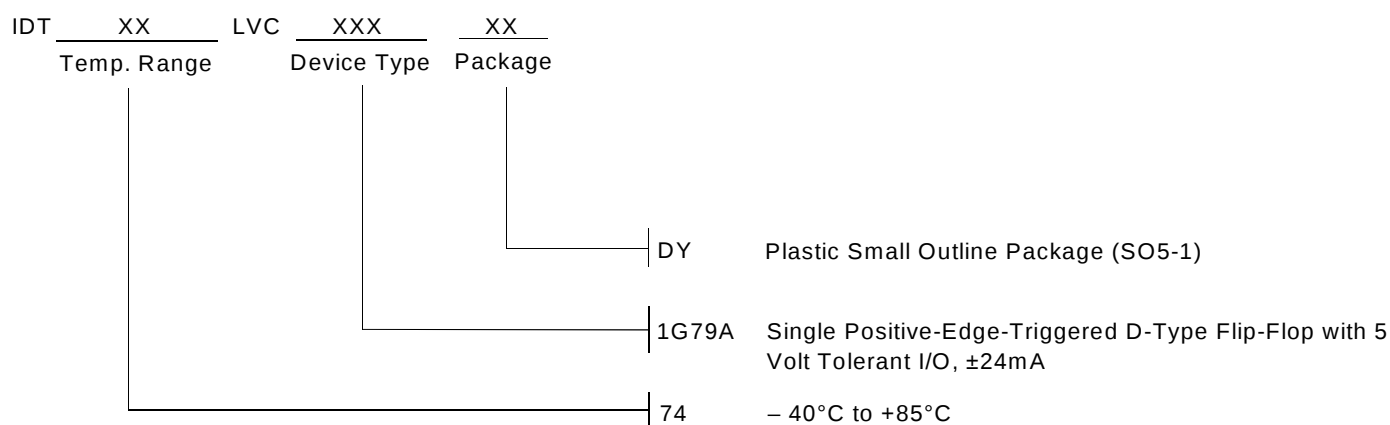
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PULSE WIDTH



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ORDERING INFORMATION



PICOGATE-LOGIC (DY) PACKAGES

Due to their small size, PicoGate-Logic packages require more complex symbolization guidelines. IDT's 5-pin PSOP (DY) packaged devices utilize a three-symbol name rule. The first symbol denotes device technology, the second symbol denotes device function, and the third symbol denotes a wafer fab/assembly site code for internal tracking.

EXAMPLES:

1. A PicoGate-Logic device with package code LR* is an IDT74LVC1G79A.
2. A PicoGate-Logic device with package code GC* is an IDT74ALVC1G04.

PICOGATE-LOGIC (DY) PACKAGE SYMBOLIZATION GUIDELINES

TECHNOLOGY	CODE	FUNCTION	CODE
ALVC	G	00	A
ALVCH	J	02	B
LVC	L	04	C
LVCH ⁽¹⁾		U04	D
		06	T
		07	V
		08	E
		14	F
		32	G
		79	R
		86	H
		125	M
		126	N
		132	Y

NOTE:

1. Code to be determined.



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